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Improving the crack resistance and fracture toughness of Cu/Ru multilayer thin films via tailoring the individual layer thickness

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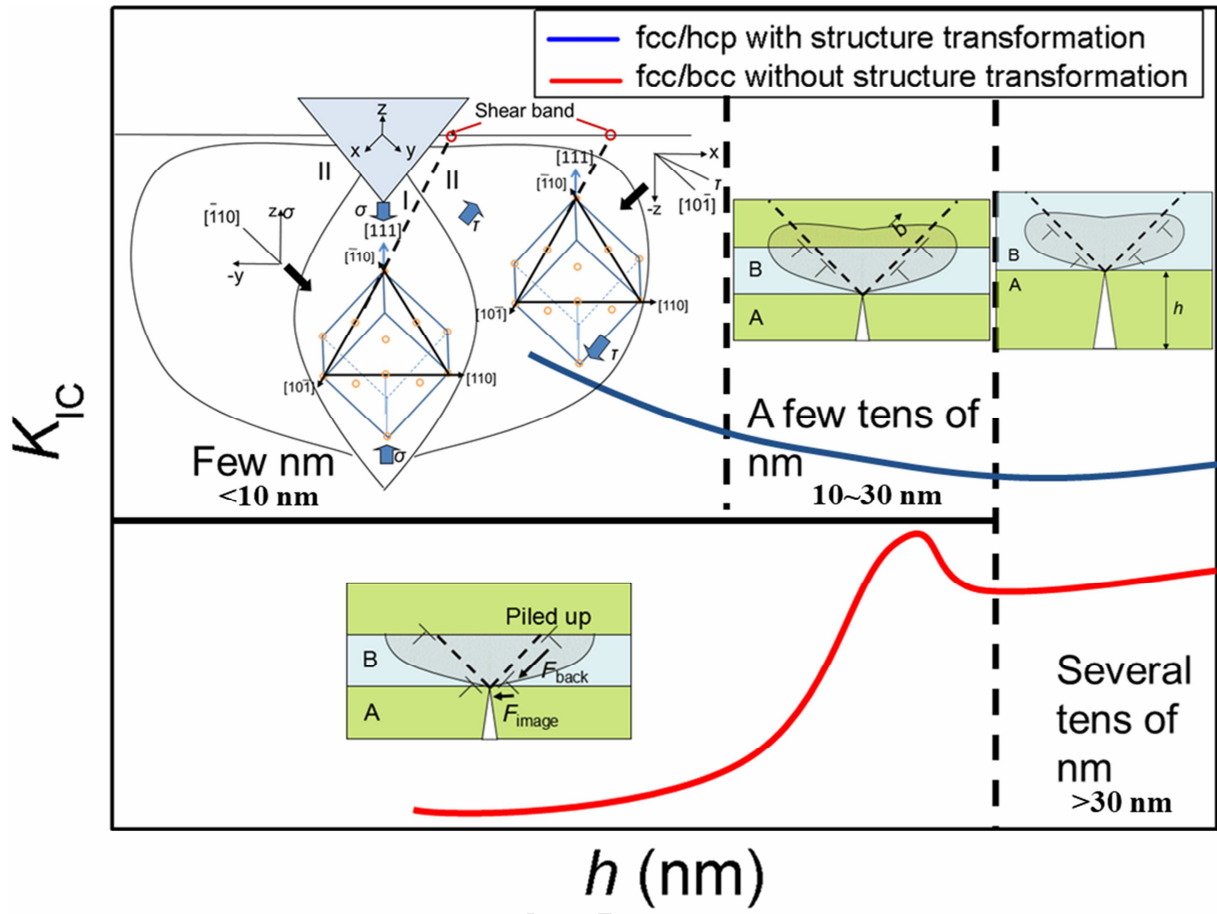
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